Title: ADDITIVE FOR ALKALINE ZINC PLATING

Abstract: The present invention refers to a process for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate, a zinc coated metallic substrate having a specific gloss as well as an aqueous alkaline plating bath for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate and the use of a zinc plating bath additive in a process for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate and for improving the optical appearance and/or the adhesion of a zinc or zinc alloy coating on a metallic substrate.
Additive for alkaline zinc plating

Field of the invention

The present invention refers to a process for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate, a zinc or zinc alloy coated metallic substrate having a specific gloss as well as an aqueous alkaline plating bath for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate and the use of a zinc plating bath additive in a process for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate for improving the optical appearance and/or the adhesion of a zinc or zinc alloy coating on a metallic substrate.

Background of the invention

The electrolytic deposition of zinc onto metallic substrates from alkaline solution for the preparation of zinc coated metallic substrates is widely used to prevent such metallic substrates from corrosion and to impart specific optical and mechanical properties on the resulting end product. A process of such electrolytic deposition typically comprises applying a current density to a metal substrate to be zinc coated while placing said substrate in a zinc plating bath. Due to the applied current, zinc ions dissolved in the zinc plating bath deposit on the metallic substrate surface such that a zinc coating is formed thereon.

In the art, several attempts for improving the electrolytic deposition of zinc onto metallic substrates in alkaline solution have been proposed. For instance, US 2012/0138473 A1 refers to a zinc plating bath additive enabling the rapid formation of a zinc coating having small variations in the thickness depending on the position on the surface of an object to be plated. The zinc plating bath additive contains a water soluble copolymer having, as the structural units, two amine compounds. WO 03/006360 A2 refers to an alkaline zinc-nickel electroplating bath that comprises zinc ions, nickel ions, a primary brightener, which is an N-methylpyridinium compound substituted at the 3-position of the pyridine ring with a carboxylate group or a group which is hydrolyzable to a carboxylate group, and a secondary brightener, which is an aliphatic amine. US 3,886,054 A refers to a non-cyanide, alkaline electroplating baths for bright zinc plating containing quarternized polymeric condensates of alkylene polyamines and 1,3-dihalo-2-propanol as grain refiners preferably in admixture with aldehyde type brighteners and mercapto substituted heterocyclic compounds capable of producing bright, fine grained deposits over a broad current density range. US 2005/133376 A1 refers to an aqueous zinc-nickel electroplating bath, including water; nickel ion; zinc ion; at least one complexing agent; and at least one non-ionic, surface active polyoxyalkylene compound, wherein the bath has an alkaline pH.
However, the preparation of zinc coated metallic substrates by the electrolytic deposition of zinc or zinc alloy onto the substrate is challenging. For instance, during the electrolytic deposition of zinc or a zinc alloy onto a metallic substrate, hydrogen is generated which tends to adhere on the coating surface as small gas bubbles resulting in a zinc or zinc alloy coating formed on the metallic substrate having worsened optical appearances. Such worsened optical appearances are typically visible on the surface in the form of stripes. In addition thereto, such formation of bubbles also decreases the adhesion of the zinc coating on the metallic substrate which may be detectable as small blisters on the surface and thus also decreased mechanical properties are obtained. Thus, the addition of surfactants into the plating bath would be desirable in order to support the formation of an even coating on the metallic substrate and thus to improve the optical appearance of the zinc or zinc alloy coated metallic substrate surface. In this regard, it is to be noted that surfactants considered as being suitable in zinc plating processes should be soluble in the plating bath. However, such water-soluble surfactants also tend to stabilize foams generated during the deposition process which may then interfere with the deposition of zinc or zinc alloy on the metallic substrate such that an uneven coating is formed thereon resulting again in optically deteriorated appearances. In contrast thereto, surfactants which are known as being sufficient as regards the non-stabilization of foams are typically insoluble in the aqueous zinc plating bath and are thus considered unsuitable in such baths.

Thus, there is a need in the art for providing a process which avoids the foregoing disadvantages and especially allows for the preparation of a zinc or zinc alloy coated metallic substrate imparting very well optical characteristics to a resulting end product while its mechanical properties are kept on a high level or even improved. In particular, it is desirable to provide a process for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate which is well balanced with regard to optical appearances resulting from the non-formation of foam and bubbles in the plating bath on the one hand and the adhesion of the zinc or zinc alloy coating on the metallic substrate on the other hand.

Accordingly, it is an object of the present invention to provide a process for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate. Furthermore, it is an object of the present invention to provide a process in which a zinc or zinc alloy coating is formed on the metallic substrate having an even thickness. It is an even further object of the present invention to provide a process in which the optical appearance of the resulting zinc or zinc alloy coating formed on the metallic substrate is improved. Another object of the present invention is to provide a process in which the mechanical properties of the resulting zinc or zinc alloy coating formed on the metallic substrate are kept on a high level or are even improved. A still further object of the present invention is to provide a process in which a good wetting of the metallic substrate surface is obtained such that an improved release of gas bubbles is caused improving
the optical appearance of the resulting zinc or zinc alloy coated metallic substrate. A further object of the present invention is to provide a process in which the obtained zinc or zinc alloy coated metallic substrate is the result of well-balanced properties with regard to the wetting behavior as well as the adhesion of the zinc or zinc alloy coating on the metallic substrate. Further objects can be gathered from the following description of the invention.

Summary of the invention

The foregoing and other objects are solved by the subject-matter of the present invention.

According to a first aspect of the present invention, a process for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate is provided. The process comprises at least the steps of:

a) providing an aqueous alkaline plating bath comprising
   i) a source of zinc ions,
   ii) a source of hydroxide ions, and
   iii) a zinc plating bath additive being at least one compound of the general formula (I).

\[ R \text{-(G}^1)\text{x}-H \]

wherein R is C4-C1 alkyl; G1 is selected from monosaccharides with 4 to 6 carbon atoms; x is in the range of from 1 to 4 and refers to average values, and

b) placing a metallic substrate in the aqueous alkaline plating bath such that a zinc or zinc alloy coating is formed on the metallic substrate.

According to another aspect of the present invention, a zinc or zinc alloy coated metallic substrate is provided having a gloss being defined by inequation (I)

\[ (G\text{Uwith})/(G\text{Uwithout}) \geq 1.05 \]  

wherein
(GUwith) is the gloss unit determined on a metallic substrate coated without using the at least one compound of the general formula (I) defined herein and as measured with a gloss meter at a measuring angle of 85°;
(GUwithout) is the gloss unit determined on a metallic substrate coated by using the at least one compound of the general formula (I) defined herein and as measured with a gloss meter at a measuring angle of 85°.
According to a further aspect of the present invention, an aqueous alkaline plating bath for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate is provided, wherein the bath comprises

a) a source of zinc ions as defined herein,

b) a source of hydroxide ions as defined herein, and

c) a zinc plating bath additive as defined herein.

According to an even further aspect of the present invention, an use of a zinc plating bath additive as defined herein in a process for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate is provided. According to a still further aspect, an use of a zinc plating bath additive as defined herein for improving the optical appearance and/or the adhesion of a zinc or zinc alloy coating on a metallic substrate is provided. According to still another aspect, an use of a zinc plating bath additive for improving the optical and/or mechanical surface properties of a zinc or zinc alloy coating on a cast iron substrate is provided.

15 Advantageous embodiments of the inventive process for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate are defined in the corresponding sub-claims.

According to one embodiment, the source of zinc ions is zinc oxide and/or the zinc ions are present in the aqueous alkaline plating bath in an amount of from 2.0 to 30.0 g/L bath.

According to another embodiment, the source of hydroxide ions is sodium hydroxide and/or the hydroxide ions are present in the aqueous alkaline plating bath in an amount of from 50.0 to 250.0 g/L bath.

25 According to yet another embodiment, in the general formula (I) R is C₄-C₈-alkyl; G¹ is selected from monosaccharides with 5 or 6 carbon atoms; and x is in the range of from 1 to 2.

According to one embodiment, in the general formula (I) R is C₄-alkyl; G¹ is glucose and/or xylose and/or arabinose and x is in the range of from 1 to 1.8.

According to another embodiment, the zinc plating bath additive is present in the aqueous alkaline plating bath in an amount of from 0.1 to 10.0 g/L bath.

30 According to yet another embodiment, the aqueous alkaline plating bath has a pH of from 12.0 to 14.0.

According to one embodiment, the aqueous alkaline plating bath further comprises at least one conventional additive selected from the group comprising brightener such as high-gloss
brightener, basic brightener and mixtures thereof, water-soluble polymers, leveling agents, water softener, complexing agents, a source of cyanide ions and mixtures thereof.

According to another embodiment, process step b) is carried out at a temperature of from 10 to 40 °C.

According to yet another embodiment, process step b) is carried out at a current density of from 0.05 to 15.0 A/dm².

According to one embodiment, the zinc or zinc alloy coating formed on the metallic substrate has a thickness of from 2.0 to 30.0 µm.

In the following, the details and preferred embodiments of the inventive process will be described in more detail. It is to be understood that these technical details and embodiments also apply to the inventive zinc or zinc alloy coated metallic substrate obtainable by the process, the inventive aqueous alkaline plating bath for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate and its use.

**Detailed description of the invention**

According to step a) of the instant process an aqueous alkaline plating bath is provided.

The term "aqueous" alkaline plating bath refers to a system in which the solvent comprises, preferably consists of, water. However, it is to be noted that said term does not exclude that the solvent comprises minor amounts of a water-miscible organic solvent selected from the group comprising methanol, ethanol, acetone, acetonitrile, tetrahydrofuran and mixtures thereof. If the solvent comprises a water-miscible organic solvent, the water-miscible organic solvent is present in an amount from 0.01 to 10.0 wt.-%, preferably from 0.01 to 7.5 wt.-%, more preferably from 0.01 to 5.0 wt.-% and most preferably from 0.01 to 2.5 wt.-%, based on the total weight of the solvent. For example, the solvent of the aqueous alkaline plating bath consists of water. If the solvent of the aqueous alkaline plating bath consists of water, the water to be used can be any water available such as tap water and/or deionised water, preferably deionised water.

The term aqueous "alkaline" plating bath refers to a system having a pH of > 7. For example, the aqueous alkaline plating bath has a pH of from 12.0 to 14.0, more preferably of from 13.0 to 14.0.
It is one requirement of the instant process that the aqueous alkaline plating bath comprises a source of zinc ions.

It is appreciated that the aqueous alkaline plating bath may contain a source of zinc ions that is known to the skilled person as being suitable as source of zinc ions in an aqueous alkaline plating bath.

For example, the source of zinc ions is selected from the group comprising zinc, zinc oxide, zinc sulfate, zinc carbonate, zinc sulfamate, zinc acetate and mixtures thereof. Preferably, the source of zinc ions is zinc oxide. Zinc oxide is present as zincate in the aqueous alkaline plating bath.

The aqueous alkaline plating bath preferably contains the source of zinc ions such that the amount of zinc ions in the bath is in a range usual for such bath. Thus, the zinc ions are preferably present in the aqueous alkaline plating bath in an amount of from 2.0 to 30.0 g/L bath, preferably from 5.0 to 25.0 g/L bath and most preferably from 5.0 to 20.0 g/L bath.

The corresponding amount of the source of zinc ions to be used in the present process is determined by appropriate calculation in order to reach the given amount of zinc ions.

In one embodiment, the aqueous alkaline plating bath comprises in addition to the source of zinc ions a further source of metal ions such that a zinc alloy coating is formed on the metallic substrate by the instant process.

It is appreciated that the further source of metal ions can be any source of metal ions that is known to the skilled person as being suitable as source of metal ions in an aqueous alkaline plating bath in combination with a source of zinc ions. However, the further source of metal ions preferably comprises ions of nickel, manganese, cobalt, iron and mixtures thereof.

Preferably, the further source of metal ions may be any source of metal ions which is soluble in the aqueous alkaline plating bath. For example, the source of metal ions is selected from the group comprising nickel sulfate, manganese chloride, cobalt sulfate, iron sulfate and mixtures thereof.

If the aqueous alkaline plating bath comprises a further source of metal ions, the bath may contain the further source of metal ions in a wide range. For example, the metal ions obtained from the further source of metal ions are present in the aqueous alkaline plating bath in an
amount of from 0.1 to 100.0 g/L bath, preferably from 0.2 to 75.0 g/L bath and most preferably from 0.5 to 50.0 g/L bath.

Accordingly, if the aqueous alkaline plating bath comprises a further source of metal ions, the bath preferably contains the zinc ions in an amount of from 2.0 to 30.0 g/L bath, preferably from 5.0 to 25.0 g/L bath and most preferably from 5.0 to 20.0 g/L bath and the metal ions obtained from the further source of metal ions in an amount of from 0.1 to 100.0 g/L bath, preferably from 0.2 to 75.0 g/L bath and most preferably from 0.5 to 50.0 g/L bath.

The corresponding amount of the further source of metal ions to be used in the present process in order to reach the given amount of metal ions is determined by appropriate calculation.

It is appreciated that the aqueous alkaline plating bath functions as catholyte. The anode can be any anode, such as stainless steel or platinum-coated titanium anodes or soluble zinc anodes, that is known to the skilled person as being suitable in processes for the electrolytic deposition of a zinc or zinc coating on a metallic substrate in which the zinc or zinc alloy coating is formed in an aqueous alkaline plating bath.

As already mentioned above, the plating bath has an alkaline pH. Thus, it is a further requirement of the instant process that the aqueous alkaline plating bath comprises a source of hydroxide ions.

It is appreciated that the aqueous alkaline plating bath comprises a source of hydroxide ions that is known to the skilled person as being suitable to adjust the pH of an aqueous alkaline plating bath to the desired alkaline pH.

For example, the source of hydroxide ions is selected from sodium hydroxide and/or potassium hydroxide, preferably sodium hydroxide.

The aqueous alkaline plating bath comprises the source of hydroxide ions in an amount being sufficient to provide the aqueous alkaline plating bath with the desired alkaline pH.

Preferably, the aqueous alkaline plating bath comprises the source of hydroxide ions in an amount such that the aqueous alkaline plating bath has a pH of > 7, preferably from 12.0 to 14.0 and most preferably of from 13.0 to 14.0. For example, the hydroxide ions are preferably present in the aqueous alkaline plating bath in an amount of from 50.0 to 250.0 g/L bath, preferably from 50.0 to 200.0 g/L bath and most preferably from 50.0 to 150.0 g/L bath.
The corresponding amount of the source of hydroxide ions to be used in the present process in order to reach the given amount of hydroxide ions is determined by appropriate calculation.

The aqueous alkaline plating bath further comprises a zinc plating bath additive. The zinc plating bath additive is at least one compound of the general formula (I),

\[ \text{R} \overset{\text{O}}{\text{-(G}^1\text{)}}_x \overset{\text{H}}{\text{R}} \]  

wherein R is C₄₋₇-alkyl; G¹ is selected from monosaccharides with 4 to 6 carbon atoms; x is in the range of from 1 to 4 and refers to average values.

Said zinc plating bath additive improves the process for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate in that only a small amount of foam or no foam is formed and, if foam is formed, in that it can be easily rinsed off from the metallic substrate. This also severely reduces the amount of foam which is attached to the zinc or zinc alloy coating on the metallic substrate when it is taken out of the aqueous alkaline plating bath such that the formation of foam marks on the coated substrate surface is clearly reduced in the present process. Thus, it was surprisingly found that the addition of the instant zinc plating bath additive in a process for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate results in a zinc or zinc alloy coated metallic substrate having improved optical appearances. Furthermore, said zinc plating bath additive has the advantage that it shows a good wetting behavior such that the release of gas bubbles is improved from the metallic substrate resulting in a coated substrate surface showing less or no stripes resulting from such bubbles. Also, the adhesion of the zinc or zinc alloy coating on the metallic substrate is excellent by using said zinc plating bath additive. Accordingly, the optical properties are improved, i.e. less or no foam marks and stripes, and the mechanical properties of the resulting zinc or zinc alloy coating formed on the metallic substrate are kept on a high level or are even improved by using said zinc plating bath additive.

The term "at least one" zinc plating bath additive means that the zinc plating bath additive comprises, preferably consists of, one or more zinc plating bath additive(s).

In one embodiment, the at least one zinc plating bath additive(s) comprises, preferably consists of, one zinc plating bath additive. Alternatively, the at least one zinc plating bath additive(s) comprises, preferably consists of, two or more zinc plating bath additives. For example, the at least one zinc plating bath additive(s) comprises, preferably consists of, two or three zinc plating bath additives. In other words, if the at least one zinc plating bath additive(s) of general formula (I) comprises, preferably consists of, two or more zinc plating bath additives, the at least one
zinc plating bath additive(s) of general formula (I) comprises, preferably consists of, a mixture of different zinc plating bath additives.

If the at least one zinc plating bath additive(s) of general formula (I) is a mixture of different zinc plating bath additives, the mixture comprises, preferably consists of, three to twenty zinc plating bath additives of general formula (I). For example, the mixture of the zinc plating bath additives of general formula (I) comprises, preferably consists of, five to fifteen zinc plating bath additive(s) of general formula (I) or the mixture of the zinc plating bath additives of general formula (I) comprises, preferably consists of, five to ten zinc plating bath additive(s) of general formula (I).

Preferably, the at least one zinc plating bath additive(s) comprises, more preferably consists of, one zinc plating bath additive.

In the general formula (I), R is C₄₋Cᵢ₉₋₀-alkyl such as substituted or unsubstituted, linear or branched C₄₋Cᵢ₉₋₀-alkyl, preferably R is C₄₋C₉₋₀-alkyl such as substituted or unsubstituted, linear or branched C₄₋C₉₋₀-alkyl, more preferably R is C₄₋C₆₋₀-alkyl such as substituted or unsubstituted, linear or branched C₄₋C₆₋₀-alkyl, even more preferably R is C₄₋C₇₋₀-alkyl such as substituted or unsubstituted, linear or branched C₄₋C₇₋₀-alkyl and still more preferably R is C₄₋C₆₋₀-alkyl such as substituted or unsubstituted, linear or branched C₄₋C₆₋₀-alkyl. For example, R is C₄₋₀-alkyl such as substituted or unsubstituted, linear or branched C₄₋₀-alkyl or R is C₅₋₀-alkyl such as substituted or unsubstituted, linear or branched C₅₋₀-alkyl or R is C₆₋₀-alkyl such as substituted or unsubstituted, linear or branched C₆₋₀-alkyl. Most preferably, R is C₄₋₀-alkyl such as substituted or unsubstituted, linear or branched C₄₋₀-alkyl such as substituted or unsubstituted, linear or branched C₄₋₀-alkyl.

As used herein, the term "alkyl" is a radical of a saturated aliphatic group, including linear chain alkyl groups and branched chain alkyl groups, wherein such linear and branched chain alkyl groups may each be optionally substituted with a hydroxyl group.

In one embodiment, R is unsubstituted linear C₄₋Cᵢ₉₋₀-alkyl, more preferably R is unsubstituted linear C₄₋C₆₋₀-alkyl, even more preferably R is unsubstituted linear C₄₋C₆₋₀-alkyl, still more preferably R is unsubstituted linear C₄₋C₇₋₀-alkyl and most preferably R is unsubstituted linear C₄₋C₆₋₀-alkyl. For example, R is unsubstituted linear C₄₋₀-alkyl or unsubstituted linear C₅₋₀-alkyl or unsubstituted linear C₆₋₀-alkyl. Most preferably R is unsubstituted linear C₄₋₀-alkyl.

Alternatively, R is unsubstituted branched C₄₋Cᵢ₉₋₀-alkyl, more preferably R is unsubstituted branched C₄₋C₉₋₀-alkyl and even more preferably R is unsubstituted branched C₄₋C₆₋₀-alkyl. For
example, R is unsubstituted branched C₅-alkyl, such as isoamyl, R is unsubstituted branched C₆-alkyl, such as 2-ethylhexyl, or unsubstituted branched C₁₀-alkyl, such as 2-propylheptyl.

In the general formula (I), G¹ is selected from monosaccharides with 4 to 6 carbon atoms. For example, G¹ is selected from tetroses, pentoses, and hexoses. Examples of tetroses are erythrose, threose, and erythulose. Examples of pentoses are ribulose, xylulose, ribose, arabinose, xylose and lyxose. Examples of hexoses are galactose, mannose and glucose. Monosaccharides may be synthetic or derived or isolated from natural products, hereinafter in brief referred to as natural saccharides or natural polysaccharides, and natural saccharides natural polysaccharides being preferred. More preferred are the following natural monosaccharides: galactose, glucose, arabinose, xylose, and mixtures of the foregoing, even more preferred are glucose, arabinose and xylose, and in particular glucose. Monosaccharides can be selected from any of their enantiomers, naturally occurring enantiomers and naturally occurring mixtures of enantiomers being preferred. Naturally, in a specific molecule only whole groups of G¹ can occur.

Thus, if G¹ in the general formula (I) is a tetrose, the tetrose may be selected from erythrose such as D-erythrose, L-erythrose and mixtures thereof, preferably D-erythrose, threose such as D-threose, L-threose and mixtures thereof, preferably D-threose, and erythulose such as D-erythulose, L-erythulose and mixtures thereof, preferably D-erythulose. If G¹ in the general formula (I) is a pentose, the pentose may be selected from ribulose such as D-ribulose, L-ribulose and mixtures thereof, preferably D-ribulose, xylulose such as D-xylulose, L-xylulose and mixtures thereof, preferably D-xylulose, ribose such as D-ribose, L-ribose and mixtures thereof, preferably D-ribose, arabinose such as D-arabinose, L-arabinose and mixtures thereof, preferably L-arabinose, xylose such as D-xylose, L-xylose and mixtures thereof, preferably D-xylose and lyxose such as D-lyxose, L-lyxose and mixtures thereof, preferably D-lyxose. If G¹ in the general formula (I) is a hexose, the hexose may be selected from galactose such as D-galactose, L-galactose and mixtures thereof, preferably D-galactose, mannose such as D-mannose, L-mannose and mixtures thereof, preferably D-mannose and glucose such as D-glucose, L-glucose and mixtures thereof, preferably D-glucose. More preferably, G¹ in the general formula (I) is glucose, preferably D-glucose, galactose, preferably D-galactose, arabinose, preferably D-arabinose, xylose, preferably D-xylose, and mixtures of the foregoing, even more preferably G¹ in the general formula (I) is glucose, preferably D-glucose, arabinose, preferably L-arabinose, and xylose, preferably D-xylose, and in particular glucose, preferably D-glucose.

In one embodiment of the present invention, G¹ is selected from monosaccharides with 6 carbon atoms, preferably from glucose, most preferably from D-glucose.
In the general formula (I), x is in the range of from 1 to 4, preferably x is in the range of from 1 to 2 and most preferably x is in the range of from 1 to 1.8. In one embodiment, x is 1. In the context of the present invention, x refers to average values, and x is not necessarily a whole number. In a specific molecule only whole groups of G can occur. It is preferred to determine x by High Temperature Gas Chromatography (HTGC), e.g. 400°C, in accordance with K. Hill et al., Alkyl Polyglycosids, VCH Weinheim, New York, Basel, Cambrigde, Tokyo, 1997, in particular pages 28 ff..

In one embodiment, the zinc plating bath additive is at least one compound of the general formula (I),

\[
\begin{align*}
\text{O} & \quad \text{\( (G^1) \)}_x \\
\text{\( \text{R} \)} & \quad \text{\( \text{H} \)} \\
& \quad \text{\( (I) \)} \\
\end{align*}
\]

wherein R is C\textsubscript{4}-C\textsubscript{6}-alkyl; G\textsuperscript{1} is selected from monosaccharides with 4 to 6 carbon atoms; x is in the range of from 1 to 4 and refers to average values.

In another embodiment, the zinc plating bath additive is at least one compound of the general formula (I),

\[
\begin{align*}
\text{p} & \quad \text{\( (G^1) \)}_x \\
\text{\( \text{R} \)} & \quad \text{\( \text{H} \)} \\
& \quad \text{\( (I) \)} \\
\end{align*}
\]

wherein R is C\textsubscript{4}-C\textsubscript{6}-alkyl; G\textsuperscript{1} is selected from monosaccharides with 4 to 6 carbon atoms; x is in the range of from 1 to 4 and refers to average values.

For example, the zinc plating bath additive is at least one compound of the general formula (I),

\[
\begin{align*}
\text{p} & \quad \text{\( (G^1) \)}_x \\
\text{\( \text{R} \)} & \quad \text{\( \text{H} \)} \\
& \quad \text{\( (I) \)} \\
\end{align*}
\]

wherein R is C\textsubscript{6}-alkyl; G\textsuperscript{1} is selected from monosaccharides with 4 to 6 carbon atoms; x is in the range of from 1 to 4 and refers to average values.

Alternatively, the zinc plating bath additive is at least one compound of the general formula (I),
wherein \( R \) is \( C_5 \)-alkyl; \( G \) is selected from monosaccharides with 4 to 6 carbon atoms; \( x \) is in the range of from 1 to 4 and refers to average values.

Alternatively, the zinc plating bath additive is at least one compound of the general formula (I),

\[
\begin{array}{c}
\text{O} \\
\text{R} \\
\text{H}
\end{array} \quad \frac{(G^1)_x}{(I)} \quad \text{wherein } R \text{ is } C_4 \text{-alkyl;} \ G^1 \text{ is selected from monosaccharides with 4 to 6 carbon atoms;} \ x \text{ is in the range of from 1 to 4 and refers to average values.}
\]

Thus, it is preferred that the zinc plating bath additive is at least one compound of the general formula (I),

\[
\begin{array}{c}
\text{p} \\
\text{R} \\
\text{H}
\end{array} \quad \frac{(G^1)_x}{(I)} \quad \text{wherein } R \text{ is } C_4 \text{-alkyl;} \ G^1 \text{ is selected from monosaccharides with 5 or 6 carbon atoms;} \ x \text{ is in the range of from 1 to 2 and refers to average values.}
\]

Preferably, the zinc plating bath additive is at least one compound of the general formula (I),

\[
\begin{array}{c}
\text{p} \\
\text{R} \\
\text{H}
\end{array} \quad \frac{(G^1)_x}{(I)} \quad \text{wherein } R \text{ is } C_4 \text{-alkyl;} \ G^1 \text{ is selected from monosaccharides with 5 or 6 carbon atoms;} \ x \text{ is in the range of from 1 to 2 and refers to average values.}
\]

For example, the zinc plating bath additive is at least one compound of the general formula (I),

\[
\begin{array}{c}
\text{p} \\
\text{R} \\
\text{H}
\end{array} \quad \frac{(G^1)_x}{(I)} \quad \text{wherein } R \text{ is } C_6 \text{-alkyl;} \ G^1 \text{ is selected from monosaccharides with 5 or 6 carbon atoms;} \ x \text{ is in the range of from 1 to 2 and refers to average values.}
Alternatively, the zinc plating bath additive is at least one compound of the general formula (I),

\[
\begin{array}{c}
R \\
\hline
H
\end{array}
\]  

\((G^1)_x\)

wherein \(R\) is \(C_5\)-alkyl; \(G^1\) is selected from monosaccharides with 5 or 6 carbon atoms; and \(x\) is in the range of from 1 to 2 and refers to average values.

Alternatively, the zinc plating bath additive is at least one compound of the general formula (I),

\[
\begin{array}{c}
R \\
\hline
H
\end{array}
\]  

\((G^1)_x\)

wherein \(R\) is \(C_4\)-alkyl; \(G^1\) is selected from monosaccharides with 5 or 6 carbon atoms; and \(x\) is in the range of from 1 to 2 and refers to average values.

In one embodiment, the zinc plating bath additive is at least one compound of the general formula (I),

\[
\begin{array}{c}
R \\
\hline
H
\end{array}
\]  

\((G^1)_x\)

wherein \(R\) is \(C_4\)-\(C_6\)-alkyl; \(G^1\) is glucose and/or xylose and/or arabinose and \(x\) is in the range of from 1 to 1.8 and refers to average values.

For example, the zinc plating bath additive is at least one compound of the general formula (I),

\[
\begin{array}{c}
R \\
\hline
H
\end{array}
\]  

\((G^1)_x\)

wherein \(R\) is \(C_6\)-alkyl; \(G^1\) is glucose and/or xylose and/or arabinose and \(x\) is in the range of from 1 to 1.8 and refers to average values.

Alternatively, the zinc plating bath additive is at least one compound of the general formula (I),
wherein R is C₅-alkyl; G¹ is glucose and/or xylose and/or arabinose and x is in the range of from 1 to 1.8 and refers to average values.

More preferably, the zinc plating bath additive is at least one compound of the general formula (I),

wherein R is C₄-alkyl; G¹ is glucose and/or xylose and/or arabinose and x is in the range of from 1 to 1.8 and refers to average values.

In an alternative embodiment, the zinc plating bath additive is at least one compound of the general formula (I),

wherein R is C₆-alkyl; G¹ is glucose and x is in the range of from 1 to 1.8 and refers to average values.

For example, the zinc plating bath additive is at least one compound of the general formula (I),

wherein R is C₆-alkyl; G¹ is glucose and x is in the range of from 1 to 1.8 and refers to average values.

Alternatively, the zinc plating bath additive is at least one compound of the general formula (I),

wherein R is C₅-alkyl; G¹ is glucose and x is in the range of from 1 to 1.8 and refers to average values.
Most preferably, the zinc plating bath additive is at least one compound of the general formula (I).

\[
\begin{array}{c}
\text{O} \\
\text{R} \\
\text{H}
\end{array}
\quad \text{(I)}
\]

wherein \( R \) is \( C_4 \)-alkyl; \( G^1 \) is glucose and \( x \) is in the range of from 1 to 1.8 and refers to average values.

If the at least one zinc plating bath additive(s) of general formula (I) comprises, preferably consists of, two or more zinc plating bath additives, the two or more zinc plating bath additives present in the aqueous alkaline plating bath differ in at least one of the groups \( R, G^1 \) and \( x \) in the general formula (I). That is to say, the groups \( R, G^1 \) and/or \( x \) can be independently selected from each other.

For example, if the at least one zinc plating bath additive(s) of general formula (I) comprises, preferably consists of, two or more zinc plating bath additives, \( R \) may be independently selected from \( C_4 \)-Cl-alkyl such as substituted or unsubstituted, linear or branched \( C_4 \)-Ci-alkyl, preferably from \( C_4 \)-C6-alkyl such as substituted or unsubstituted, linear or branched \( C_4 \)-C9-alkyl, more preferably from \( C_4 \)-C8-alkyl such as substituted or unsubstituted, linear or branched \( C_4 \)-C6-alkyl, even more preferably from \( C_4 \)-C7-alkyl such as substituted or unsubstituted, linear or branched \( C_4 \)-C7-alkyl, still more preferably from \( C_4 \)-C6-alkyl such as substituted or unsubstituted, linear or branched \( C_4 \)-C6-alkyl and most preferably from \( C_4 \)-alkyl such as substituted or unsubstituted, linear or branched \( C_4 \)-alkyl or \( C_6 \)-alkyl such as substituted or unsubstituted, linear or branched \( C_5 \)-alkyl or \( C_6 \)-alkyl such as substituted or unsubstituted, linear or branched \( C_6 \)-alkyl, for each zinc plating bath additive, while \( G^1 \) and \( x \) in the general formula (I) are the same for each zinc plating bath additive. Alternatively, \( x \) may be independently selected from the range of from 1 to 4, preferably from the range of from 1 to 2 and most preferably from the range of from 1 to 1.8, while \( R \) and \( G^1 \) in the general formula (I) are the same for each zinc plating bath additive. Alternatively, \( G^1 \) may be independently selected from monosaccharides with 4 to 6 carbon atoms, preferably from monosaccharides with 5 or 6 carbon atoms and more preferably from glucose and/or xylose and/or arabinose for each zinc plating bath additive, while \( R \) and \( x \) in the general formula (I) are the same for each zinc plating bath additive. For example, if the at least one zinc plating bath additive(s) of general formula (I) comprises, preferably consists of, two or more zinc plating bath additives, preferably two zinc plating bath additives, \( G^1 \) is glucose for one zinc plating bath additive and \( G^1 \) is xylose for another zinc plating bath additive, while \( R \) and \( x \) in the general formula (I) are the same for each zinc plating bath additive. Alternatively, if the at least one zinc plating bath additive(s) of general formula (I)
comprises, preferably consists of, two or more zinc plating bath additives, preferably two zinc plating bath additives, $G^1$ is arabinose for one zinc plating bath additive and $G^1$ is xylose for another zinc plating bath additive, while $R$ and $x$ in the general formula (I) are the same for each zinc plating bath additive. Alternatively, if the at least one zinc plating bath additive(s) of general formula (I) comprises, preferably consists of, two or more zinc plating bath additives, preferably three zinc plating bath additives, $G^1$ is glucose for one zinc plating bath additive and $G^1$ is xylose for another zinc plating bath additive and $G^1$ is arabinose for another zinc plating bath additive, while $R$ and $x$ in the general formula (I) are the same for each zinc plating bath additive. Further examples of advantageous mixtures of monosaccharides $G^1$ are described in the example section of, for example, DE 695 04 158 T2 and DE 697 12 602 T2, the disclosures which are herewith incorporated by reference. Examples of advantageous mixtures of monosaccharides $G^1$ with artificially prepared monosaccharides are also described in, for example, DE 695 04 158 T2 and DE 697 12 602 T2, the disclosures which are herewith incorporated by reference.

In one embodiment, the at least one zinc plating bath additive(s) of general formula (I) is an alkyl glycosid.

It is appreciated that the term "glycosid" refers to $(G^1)_x$ in the general formula (I) as defined above. Preferably, the term "glycosid" refers to $(G^1)_x$ in the general formula (I) in which $x$ is above 1. Thus, the term "glycosid" preferably refers to $(G^1)_x$ being an oligosaccharide, more preferably a disaccharide, wherein the at least two monosaccharides $G^1$ are selected from xylose, glucose, galactose and arabinose. For example, the term "glycosid" refers to $(G^1)_x$ being a disaccharide composed of xylose and glucose or xylose and galactose or xylose and arabinose or glucose and galactose or glucose and arabinose or galactose and arabinose, more preferably xylose and glucose.

For example, the at least one zinc plating bath additive(s) of general formula (I) is an alkyl glycosid, wherein the alkyl group is $C_4$-$C_{10}$-alkyl such as substituted or unsubstituted, linear or branched $C_4$-$C_{10}$-alkyl, preferably $C_4$-$C_9$-alkyl such as substituted or unsubstituted, linear or branched $C_4$-$C_9$-alkyl, more preferably $C_4$-$C_8$-alkyl such as substituted or unsubstituted, linear or branched $C_4$-$C_8$-alkyl, even more preferably $C_4$-$C_7$-alkyl such as substituted or unsubstituted, linear or branched $C_4$-$C_7$-alkyl, still more preferably $C_4$-$C_6$-alkyl such as substituted or unsubstituted, linear or branched $C_4$-$C_6$-alkyl and most preferably $C_4$-alkyl such as substituted or unsubstituted, linear or branched $C_4$-alkyl or $C_5$-alkyl such as substituted or unsubstituted, linear or branched $C_5$-alkyl or $C_6$-alkyl such as substituted or unsubstituted, linear or branched $C_6$-alkyl.
Preferably, the at least one zinc plating bath additive(s) of general formula (I) is an alkyl glycosid selected from the group comprising hexyl glycosid, isoamyl glycosid, butyl glycosid, 2-ethylhexyl glycosid and mixtures thereof. More preferably, the at least one zinc plating bath additive(s) of general formula (I) is an alkyl glycosid selected from isoamyl glycosid, butyl glycosid and mixtures thereof.

In one embodiment, the at least one zinc plating bath additive(s) of general formula (I) is a mixture of different zinc plating bath additives, wherein the mixture preferably comprises, more preferably consists of, butyl glycosid and a further zinc plating bath additive selected from the group comprising isoamyl glucosid, isoamyl xylosid, isoamyl glycosid and mixtures thereof. For example, the mixture of different zinc plating bath additives comprises, preferably consists of, butyl glycosid and isoamyl glycosid or isoamyl xylosid or isoamyl glucosid. Alternatively, the mixture of different zinc plating bath additives comprises, preferably consists of, butyl xylosid and a further zinc plating bath additive selected from the group comprising isoamyl glucosid, isoamyl xylosid, isoamyl glycosid and mixtures thereof. For example, the mixture of different zinc plating bath additives comprises, preferably consists of, butyl xylosid and isoamyl glucosid or isoamyl xylosid or isoamyl glycosid. Alternatively, the mixture of different zinc plating bath additives comprises, preferably consists of, hexyl glycosid and a further zinc plating bath additive selected from the group comprising butyl glucosid, butyl xylosid, butyl glycosid, isoamyl glucosid, isoamyl xylosid, isoamyl glycosid and mixtures thereof. For example, the mixture of different zinc plating bath additives comprises, preferably consists of, hexyl xylosid and a further zinc plating bath additive selected from the group comprising butyl glucosid, butyl xylosid, butyl glycosid, isoamyl glucosid, isoamyl xylosid, isoamyl glycosid and mixtures thereof. For example, the mixture of different zinc plating bath additives comprises, preferably consists of, hexyl xylosid and butyl glucosid or butyl xylosid or butyl glycosid or isoamyl glucosid or isoamyl xylosid or isoamyl glycosid. Alternatively, the mixture of different zinc plating bath additives comprises, preferably consists of, hexyl glycosid and a further zinc plating bath additive selected from the group comprising butyl glucosid, butyl xylosid, butyl glycosid, isoamyl glucosid, isoamyl xylosid, isoamyl glycosid and mixtures thereof. For example, the mixture of different zinc plating bath additives comprises, preferably consists of, hexyl xylosid and butyl glucosid or butyl xylosid or butyl glycosid or isoamyl glucosid or isoamyl xylosid or isoamyl glycosid. Alternatively, the mixture of different zinc plating bath additives comprises, preferably consists of, hexyl glycosid and a further zinc plating bath additive selected from the group comprising butyl glucosid, butyl xylosid, butyl glycosid, isoamyl glucosid, isoamyl xylosid, isoamyl glycosid and mixtures thereof. For example, the mixture of different zinc plating bath additives comprises, preferably consists of, hexyl glycosid and butyl glucosid or butyl xylosid or butyl glycosid or isoamyl glucosid or isoamyl xylosid or isoamyl glycosid. Alternatively, the mixture of different zinc plating bath additives comprises, preferably consists of, hexyl xylosid and a further zinc plating bath additive selected from the group comprising butyl glucosid, butyl xylosid, butyl glycosid, isoamyl glucosid, isoamyl xylosid, isoamyl glycosid and mixtures thereof. For example, the mixture of different zinc plating bath additives comprises, preferably consists of, hexyl glycosid and butyl glucosid or butyl xylosid or butyl glycosid or isoamyl glucosid or isoamyl xylosid or isoamyl glycosid. Alternatively, the mixture of different zinc plating bath additives comprises, preferably consists of, hexyl glycosid and a further zinc plating bath additive selected from the group comprising butyl glucosid, butyl xylosid, butyl glycosid, isoamyl glucosid, isoamyl xylosid, isoamyl glycosid and mixtures thereof. For example, the mixture of different zinc plating bath additives comprises, preferably consists of, hexyl glycosid and butyl glucosid or butyl xylosid or butyl glycosid or isoamyl glucosid or isoamyl xylosid or isoamyl glycosid.
glycosid. Alternatively, the mixture of different zinc plating bath additives comprises, preferably consists of, 2-ethylhexyl glucosid and a further zinc plating bath additive selected from the group comprising butyl glucosid, butyl xylosid, butyl glycosid, isoamyl glucosid, isoamyl xylosid, isoamyl glycosid and mixtures thereof. For example, the mixture of different zinc plating bath additives comprises, preferably consists of, 2-ethylhexyl glucosid and butyl glucosid or butyl xylosid or butyl glycosid or isoamyl glucosid or isoamyl xylosid or isoamyl glycosid. Alternatively, the mixture of different zinc plating bath additives comprises, preferably consists of, 2-ethylhexyl xylosid and a further zinc plating bath additive selected from the group comprising butyl glucosid, butyl xylosid, butyl glycosid, isoamyl glucosid, isoamyl xylosid, isoamyl glycosid and mixtures thereof. For example, the mixture of different zinc plating bath additives comprises, preferably consists of, 2-ethylhexyl xylosid and butyl glucosid or butyl xylosid or butyl glycosid or isoamyl glucosid or isoamyl xylosid or isoamyl glycosid. Alternatively, the mixture of different zinc plating bath additives comprises, preferably consists of, 2-ethylhexyl glycosid and a further zinc plating bath additive selected from the group comprising butyl glucosid, butyl xylosid, butyl glycosid, isoamyl glucosid, isoamyl xylosid, isoamyl glycosid and mixtures thereof. For example, the mixture of different zinc plating bath additives comprises, preferably consists of, 2-ethylhexyl glycosid and butyl glucosid or butyl xylosid or butyl glycosid or isoamyl glucosid or isoamyl xylosid or isoamyl glycosid.

In one embodiment, the at least one zinc plating bath additive(s) of general formula (I) is selected from alkyl glucosid, alkyl xylosid and mixtures thereof. For example, the at least one zinc plating bath additive(s) of general formula (I) is an alkyl glucosid and/or alkyl xylosid, wherein the alkyl group is C4-C16-alkyl such as substituted or unsubstituted, linear or branched C4-C10-alkyl, preferably C4-C9-alkyl such as substituted or unsubstituted, linear or branched C9-alkyl, more preferably C4-C6-alkyl such as substituted or unsubstituted, linear or branched C4-C5-alkyl, even more preferably C4-C7-alkyl such as substituted or unsubstituted, linear or branched C4-C7-alkyl, still more preferably C4-C6-alkyl such as substituted or unsubstituted, linear or branched C4-C6-alkyl and most preferably C4-alkyl such as substituted or unsubstituted, linear or branched C4-alkyl or C5-alkyl such as substituted or unsubstituted, linear or branched C5-alkyl or C6-alkyl such as substituted or unsubstituted, linear or branched C6-alkyl.

Preferably, the at least one zinc plating bath additive(s) of general formula (I) is preferably selected from the group comprising butyl glucosid, isoamyl glucosid, 2-ethylhexyl glycosid, 2-propylhexyl glycosid, isoamyl xylosid, hexyl glycosid, 2-isopropyl-5-methylhexanol glycosid, 2-isopropyl-5-methylhexanol xylosid, C8-C10 glycosid and mixtures thereof. More preferably, the at least one zinc plating bath additive(s) of general formula (I) is selected from the group comprising butyl glucosid, isoamyl glucosid, 2-ethylhexyl glycosid, 2-propylhexyl glycosid, hexyl glycosid and mixtures thereof. Even more preferably, the at least one zinc plating bath
additive(s) of general formula (I) is selected from butyl glycosid, isoamyl glycosid and mixtures thereof. Most preferably, the at least one zinc plating bath additive(s) of general formula (I) is butyl glycosid.

In one embodiment, the at least one zinc plating bath additive(s) of general formula (I) is preferably selected from the group comprising butyl glucosid, isoamyl glucosid, 2-ethylhexyl glucosid, 2-propylhexyl glucosid, isoamyl xylosid, hexyl glucosid, 2-isopropyl-5-methylhexanol glucosid, 2-isopropyl-5-methylhexanol xylosid, C8-C10 glucosid and mixtures thereof. More preferably, the at least one zinc plating bath additive(s) of general formula (I) is selected from the group comprising butyl glucosid, isoamyl glucosid, 2-ethylhexyl glucosid, 2-propylhexyl glucosid, hexyl glucosid and mixtures thereof. Even more preferably, the at least one zinc plating bath additive(s) of general formula (I) is selected from butyl glucosid, hexyl glucosid and mixtures thereof. Most preferably, the at least one zinc plating bath additive(s) of general formula (I) is butyl glucosid.

It is appreciated that the compounds of the general formula (I) can be present in the alpha and/or beta conformation. For example, the at least one zinc plating bath additive(s) of general formula (I) is in the alpha or beta conformation, preferably beta conformation. Alternatively, the at least one zinc plating bath additive(s) of general formula (I) is in the alpha and beta conformation.

If the at least one zinc plating bath additive(s) of general formula (I) is in the alpha and beta conformation, the at least one zinc plating bath additive(s) of general formula (I) comprise the alpha and beta conformation preferably in a ratio (a/β) from 10:1 to 1:10, more preferably from 5:1 to 1:10, even more preferably from 4:1 to 1:10 and most preferably from 3:1 to 1:10.

It is appreciated that compounds of the general formula (I) are well known in the art and can be prepared by methods well known to the skilled person.

In one embodiment of the present invention, the compound of the general formula (I) is present in the bleached form or the unbleached form, preferably the bleached form.

The aqueous alkaline plating bath preferably contains the at least one zinc plating bath additive(s) of general formula (I) in an amount of from 0.1 to 10.0 g/L bath, preferably from 0.1 to 7.5 g/L bath and most preferably from 0.1 to 5.0 g/L bath.
The corresponding amount of the at least one zinc plating bath additive(s) of general formula (I) to be used in the present process is based on the active amount of the at least one zinc plating bath additive(s) of general formula (I).

The aqueous alkaline plating bath may further comprise at least one conventional additive selected from the group comprising brightener, water-soluble polymers, leveling agents, water softener, complexing agents, a source of cyanide ions and mixtures thereof.

For example, the aqueous alkaline plating bath may comprise known brightener, which can be classified as basic brightener and high-gloss brightener. Examples of advantageous basic brighteners are polyethyleneimines or their derivatives and/or reaction products of epichlorohydrin with heterocyclic nitrogen compounds such as imidazole, 1,2,4-triazole or their derivatives as described in, for example, US patent number 4,166,778. Preferably, the basic brightener is a reaction product of epichlorohydrin with heterocyclic nitrogen compounds such as imidazole, 1,2,4-triazole or their derivatives as described in, for example, US patent number 4,166,778, the disclosure which is herewith incorporated by reference.

The aqueous alkaline plating bath preferably comprises a basic brightener in a total amount of from 0.1 to 15.0 g/L bath, and preferably from 1.0 to 10.0 g/L bath.

In general, the high-gloss brightener includes substances from a large variety of classes such as for example brightener selected from the group comprising aldehydes, ketones, amines, polyvinyl alcohol, polyvinyl pyrrolidone, sulfur compounds, polyamines or heterocyclic nitrogen compounds and mixtures thereof as described in, for example, US patent number 6,652,728 B1 and US patent number 4,496,439 and WO 2007/147603 A2, the disclosures which are herewith incorporated by reference.

Preferably, the high-gloss brightener is n-benzyl nicotinat.

The aqueous alkaline plating bath preferably comprises the high-gloss brightener in a total amount of from 0.01 to 2.0 g/L bath, preferably from 0.01 to 0.5 g/L bath.

Additionally or alternatively, the aqueous alkaline plating bath comprises known water-soluble polymers as polarization reagents such as cationic polymers, anionic polymers, amphoteric polymers and mixtures thereof, preferably cationic polymers. Examples of advantageous polarization reagents are the reaction products of N,N'-bis[3-(dialkylamino)alkyl]ureas with 1,ω-dihalogen aikanes as described in, for example, US patent number 6,652,728 B1, the disclosure which is herewith incorporated by reference.
The instant aqueous alkaline plating bath preferably comprises the water-soluble polymer in a total amount of from 0.1 to 15.0 g/L bath, preferably from 1.0 to 10.0 g/L bath.

Additionally or alternatively, the aqueous alkaline plating bath comprises known leveling agents such as 3-mercapto-1,2,4-triazole and/or thiourea, preferably thiourea. The instant aqueous alkaline plating bath preferably comprises the leveling agent in a total amount of from 0.1 to 2.0 g/L bath, preferably from 0.1 to 1.0 g/L bath.

Additionally or alternatively, the aqueous alkaline plating bath comprises known water softener such as EDTA, sodium silicates, tartaric acid and mixtures thereof. The instant aqueous alkaline plating bath preferably comprises the water softener in a total amount of from 0.1 to 2.0 g/L bath, preferably from 0.1 to 1.0 g/L bath.

Additionally or alternatively, the aqueous alkaline plating bath comprises known complexing agents such as sodium gluconate, diethanolamine, triethanolamine, polyethylenediamine, EDTA, aminotris(methyleneephosphonic acid), sorbitol, sucrose and mixtures thereof. The instant aqueous alkaline plating bath preferably comprises the complexing agent in a total amount of from 0.1 to 100.0 g/L bath, preferably from 0.1 to 50.0 g/L bath.

Additionally or alternatively, the aqueous alkaline plating bath comprises known sources of cyanide ions such as so sodium cyanide, potassium cyanide and mixtures thereof. The instant aqueous alkaline plating bath preferably comprises the source of cyanide ions in a total amount of from 25.0 to 150.0 g/L bath, preferably from 50.0 to 100.0 g/L bath and most preferable about 75 g/L bath.

According to step b) of the instant process, a metallic substrate is placed in the aqueous alkaline plating bath such that a zinc or zinc alloy coating is formed on the metallic substrate.

It is appreciated that the aqueous alkaline plating bath of the invention can be used for all kinds of metallic substrates. Examples of useful metallic substrates include steel, stainless steel, chrome-molybdenum steel, copper, copper-zinc alloys, cast iron and the like.

In one embodiment, the metallic substrate is selected from steel, stainless steel, chrome-molybdenum steel, copper, copper-zinc alloys and the like. In an alternative embodiment, the metallic substrate is cast iron.
Preferably, the electrolytic deposition of the zinc or zinc alloy coating on the metallic substrate such that a zinc or zinc alloy coating is formed thereon in process step b) is carried out at a temperature of from 10 to 40 °C, preferably from 15 to 35 °C and most preferably from 15 to 30 °C such as of about room temperature.

Additionally or alternatively, the electrolytic deposition of the zinc or zinc alloy coating on the metallic substrate such that a zinc or zinc alloy coating is formed thereon in process step b) is carried out at a current density of from 0.05 to 15.0 A/dm\(^2\), preferably from 0.1 to 7.0 A/dm\(^2\) and most preferably from 0.1 to 5.0 A/dm\(^2\).

In one embodiment, process step b) is carried out at a temperature of from 10 to 40 °C, preferably from 15 to 35 °C and most preferably from 15 to 30 °C such as of about room temperature and at a current density of from 0.05 to 15.0 A/dm\(^2\), preferably from 0.1 to 7.0 A/dm\(^2\) and most preferably from 0.1 to 5.0 A/dm\(^2\).

The zinc or zinc alloy coating formed on the metallic substrate by the instant process preferably has a thickness of from 2.0 to 30.0 \(\mu\text{m}\), more preferably from 2.0 to 25.0 \(\mu\text{m}\) and most preferably from 5.0 to 25.0 \(\mu\text{m}\).

It is appreciated that the zinc or zinc alloy coated metallic substrate obtained by the instant process has very well optical and mechanical characteristics. For example, the zinc or zinc alloy coated metallic substrate surface has high gloss at low amount of optical deteriorations such as stripes and/or foam marks generated on the zinc or zinc alloy coated metallic substrate during the instant process. In one embodiment, the zinc or zinc alloy coated metallic substrate obtained by the instant process has high gloss and is free of optical deteriorations such as stripes and/or foam marks generated on the zinc or zinc alloy coated metallic substrate.

Furthermore, the zinc or zinc alloy coated metallic substrate provides an excellent adhesion of the zinc or zinc alloy coating on the metallic substrate. Accordingly, the zinc or zinc alloy coated metallic substrate obtained by the instant process has an improved optical appearance and/or adhesion of the zinc or zinc alloy coating on the metallic substrate.

In view of the advantages obtained, the present invention is thus further directed to a zinc or zinc alloy coated metallic substrate having a gloss being defined by inequation (I)

\[
\text{(GUwith)} \div \text{(GUwithout)} \geq 1.05 \quad (I)
\]

wherein
(GUwithout) is the gloss unit determined on a metallic substrate coated without using the at least one compound of the general formula (I) defined herein and as measured with a gloss meter at a measuring angle of 85°.

(GUwith) is the gloss unit determined on a metallic substrate coated by using the at least one compound of the general formula (I) defined herein and as measured with a gloss meter at a measuring angle of 85°.

Preferably, the zinc or zinc alloy coated metallic substrate has a gloss being defined by inequation (la)

\[
\frac{(GU\text{with})}{(GU\text{without})} \geq 1.1 \quad \text{(la)}
\]

wherein

(GUwithout) is the gloss unit determined on a metallic substrate coated without using the at least one compound of the general formula (I) defined herein and as measured with a gloss meter at a measuring angle of 85°.

(GUwith) is the gloss unit determined on a metallic substrate coated by using the at least one compound of the general formula (I) defined herein and as measured with a gloss meter at a measuring angle of 85°.

More preferably, the zinc or zinc alloy coated metallic substrate has a gloss being defined by inequation (lb)

\[
\frac{(GU\text{with})}{(GU\text{without})} \geq 1.3 \quad \text{(lb)}
\]

wherein

(GUwithout) is the gloss unit determined on a metallic substrate coated without using the at least one compound of the general formula (I) defined herein and as measured with a gloss meter at a measuring angle of 85°.

(GUwith) is the gloss unit determined on a metallic substrate coated by using the at least one compound of the general formula (I) defined herein and as measured with a gloss meter at a measuring angle of 85°.

Preferably, the zinc or zinc alloy coated metallic substrate has a gloss being defined by inequation (lc)

\[
\frac{(GU\text{with})}{(GU\text{without})} \geq 1.5 \quad \text{(lc)}
\]

wherein
(GUwithout) is the gloss unit determined on a metallic substrate coated without using the at least one compound of the general formula (I) defined herein and as measured with a gloss meter at a measuring angle of 85°.

(GUwith) is the gloss unit determined on a metallic substrate coated by using the at least one compound of the general formula (I) defined herein and as measured with a gloss meter at a measuring angle of 85°.

For example, the zinc or zinc alloy coated metallic substrate has a gloss being defined by inequation (Id)

\[ 2.0 \leq \frac{\text{(GUwith)}}{\text{(GUwithout)}} \geq 1.5 \]  

(Id)

wherein

(GUwithout) is the gloss unit determined on a metallic substrate coated without using the at least one compound of the general formula (I) defined herein and as measured with a gloss meter at a measuring angle of 85°.

(GUwith) is the gloss unit determined on a metallic substrate coated by using the at least one compound of the general formula (I) defined herein and as measured with a gloss meter at a measuring angle of 85°.

It is appreciated that the gloss unit is measured with the gloss meter Micro-Tri-Gloss of BYK Gardner, Germany, and is the average of ten measurements.

In one embodiment, the zinc or zinc alloy coated metallic substrate is obtainable by the process for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate as defined herein.

The instant invention is further directed to a zinc or zinc alloy coated metallic substrate obtainable by the process of the instant invention.

Furthermore, the present invention is directed to an aqueous alkaline plating bath as defined herein for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate. In addition thereto, the present invention is directed to the use of a zinc plating bath additive as defined herein in a process for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate. Furthermore, the present invention is directed to the use of a zinc plating bath additive as defined herein for improving the optical appearance and/or adhesion of a zinc or zinc alloy coating on a metallic substrate. The metallic substrate is preferably selected from steel, stainless steel, chrome-molybdenum steel, copper, copper-zinc alloys and the like.
The present invention is also directed to an aqueous alkaline plating bath as defined herein for the electrolytic deposition of a zinc or zinc alloy coating on a cast iron substrate. In addition thereto, the present invention is directed to the use of a zinc plating bath additive as defined herein in a process for the electrolytic deposition of a zinc or zinc alloy coating on a cast iron substrate. Furthermore, the present invention is directed to the use of a zinc plating bath additive as defined herein for improving the optical appearance and/or adhesion of a zinc or zinc alloy coating on a cast iron substrate.

The scope and interest of the invention will be better understood based on the following examples which are intended to illustrate certain embodiments of the invention and are non-limitative.

**EXAMPLES**

**Example 1**

The properties of the present zinc plating bath additives on the formation of foam were demonstrated in aqueous alkaline plating baths for which an electrolyte composition as outlined in table 1 below was prepared.

<table>
<thead>
<tr>
<th>Ingredient</th>
<th>Amount based on bath</th>
</tr>
</thead>
<tbody>
<tr>
<td>Zinc oxide</td>
<td>14.94 g/L</td>
</tr>
<tr>
<td>Sodium hydroxide</td>
<td>130.0 g/L</td>
</tr>
<tr>
<td>Sodium carbonate</td>
<td>40.0 g/L</td>
</tr>
</tbody>
</table>

Table 1: Electrolyte composition of the aqueous alkaline plating bath

To the electrolyte composition of table 1 further additives as outlined in table 2 below were added.

<table>
<thead>
<tr>
<th>Further additive</th>
<th>Amount based on bath</th>
</tr>
</thead>
<tbody>
<tr>
<td>Polarization reagent</td>
<td>4.8 g/L</td>
</tr>
<tr>
<td>Basic brightener</td>
<td>4.4 g/L</td>
</tr>
<tr>
<td>High-gloss brightener</td>
<td>50.0 mg/L</td>
</tr>
</tbody>
</table>

Table 2: Further additives of the aqueous alkaline plating bath

*: the polarization reagent is a commercially available cationic reaction product of N,N'-bis[3-(dialkylamino)alkyl]ureas with 1,ω-dihalogen alkane having an active content of ~ 62 wt.-%; the basic brightener is a commercially available copolymer of imidazole and epichlorohydrin having
an active content of ~ 45 wt.-% and the high-gloss brightener is a commercially available n-benzylnicotinate having an active content of ~ 48 wt.-%.

*: amount of ingredient is base on the amount of the active material.

To the aqueous alkaline plating bath obtained from the ingredients and the further additives described in tables 1 and 2, a zinc plating bath additive as outlined in table 3 below was added in an amount of 1.0 g/L bath, based on the active material. Examples marked with (+) serve for comparison.

The electrodeposition of the zinc coating on the substrate was carried out in a hull cell in accordance with DIN 50 957. Each bath was added to a 250 mL hull cell in which a steel panel was plated at 1 A for 30 min. The steel panels (steel number 1.0330 according to EN 10027-2) had the dimensions 70x100x0.3 mm. Before the steel panel was placed in the hull cell, the panel was acid cleaned by using hydrochloric acid (15%), subjected to an electrolytic degreasing and rinsed with water. A stainless steel anode served as anode. The bath was operated at room temperature (about 20 °C ± 1 °C).

The optical appearance of the obtained zinc coated metallic substrate and the foam development during the process are summarized in table 3 below.

Table 3: The zinc plating bath additive, optical appearance of the obtained zinc coated substrate and foam development

<table>
<thead>
<tr>
<th>Test</th>
<th>Zinc plating bath additive</th>
<th>Appearance</th>
<th>Foam development</th>
</tr>
</thead>
<tbody>
<tr>
<td>1(+)</td>
<td>--</td>
<td>matt finish, streaky; HCD: matt, rare stripes</td>
<td>rare foam development, foam remains in the bath</td>
</tr>
<tr>
<td>2</td>
<td>Butyl glucosid</td>
<td>matt finish, streaky; HCD, MCD: improved to test 1</td>
<td>rare foam development, foam remains in the bath</td>
</tr>
<tr>
<td>3</td>
<td>Isoamyl xylosid</td>
<td>matt finish, streaky; MCD: improved to test 1</td>
<td>rare foam development, foam remains in the bath</td>
</tr>
<tr>
<td>4</td>
<td>Hexyl glucosid</td>
<td>matt finish, streaky; MCD: improved to test 1</td>
<td>rare foam development, foam remains in the bath</td>
</tr>
</tbody>
</table>

From table 3, it can be gathered that a zinc coated metallic substrate prepared by using the zinc plating bath additive of the instant invention shows improved optical characteristic compared to a zinc coated metallic substrate prepared without using the zinc plating bath additive of the instant invention.
Example 2
The properties of the present zinc plating bath additives on the gloss of a coated substrate were
determined in aqueous alkaline plating baths for which an electrolyte/additive composition as
outlined in table 4 below was prepared.

Table 4: Electrolyte composition of the aqueous alkaline plating bath

<table>
<thead>
<tr>
<th>Ingredient</th>
<th>Amount based on bath</th>
</tr>
</thead>
<tbody>
<tr>
<td>Zinc oxide</td>
<td>9.34 g/L</td>
</tr>
<tr>
<td>Sodium hydroxide</td>
<td>97.0 g/L</td>
</tr>
<tr>
<td>Sodium carbonate</td>
<td>35.0 g/L</td>
</tr>
<tr>
<td>Polarization reagent(^1)</td>
<td>7.7 g/L</td>
</tr>
<tr>
<td>Basic brighthene (^2)</td>
<td>7.0 g/L</td>
</tr>
<tr>
<td>High-gloss brighthene (^3)</td>
<td>50.0 mg/L</td>
</tr>
<tr>
<td>Butyl glucosid</td>
<td>1.0 g/L</td>
</tr>
</tbody>
</table>

\(^1\): the polarization reagent is a commercially available cationic reaction product of N,N'-bis[3-(dialkylamino)alkyl]ureas with I,ω-dihalogen alkane having an active content of ~ 62 wt.-%;
\(^2\): the basic brightener is a commercially available copolymer of imidazole and epichlorohydin
having an active content of ~ 45 wt.-%; \(^3\): and the high-gloss brightener is a commercially available n-benzyl nicotinate having an active content of ~ 48 wt.-%.

The electrodeposition of the zinc coating on the substrate was carried out in a hull cell in
accordance with DIN 50 957. The bath was added to a 250 mL hull cell in which a steel panel
was plated at 1 A for 40 min. The steel panels (steel number 1.0330 according to EN 10027-2)
had the dimensions 70x100x0.3 mm. Before the steel panel was placed in the hull cell, the
panel was acid cleaned by using hydrochloric acid (15%), subjected to an electrolytic
degreasing and rinsed with water. A stainless steel anode served as anode. The bath was
operated at room temperature (about 20 °C ± 1 °C).

The optical appearance of the obtained zinc coated metallic substrate and of a reference
sample being coated in the absence of butyl glucosid are summarized in table 5 below.
Furthermore, the gloss unit determined by using the gloss meter Micro-Tri-Gloss of BYK
Gardner, Germany (serial number: 9 014 327) at a measuring angle of 85° for the metallic
substrate coated with a zinc plating bath additive in accordance with the present invention as
well as for the reference sample, i.e. the metallic substrate is coated in the absence of the zinc
plating bath additive of the present application, are also outlined in table 5 below. The set-up is
carried out in accordance with the operating instruction manual of the gloss meter Micro-Tri-
Gloss. The gloss unit values are the average of ten measurements. The standard deviation of the gloss unit is ± 2 GU (GU = gloss unit).

Table 5: Optical appearance

<table>
<thead>
<tr>
<th>Zinc plating bath additive</th>
<th>Appearance</th>
<th>Gloss Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>--</td>
<td>Glossy finish with rare stripes</td>
<td>71.4</td>
</tr>
<tr>
<td>Butyl glucosid</td>
<td>Glossy finish with rare stripes, less strips</td>
<td>113.9</td>
</tr>
</tbody>
</table>

From table 5, it can be gathered that a zinc coated metallic substrate prepared by using the zinc plating bath additive of the instant invention shows improved gloss compared to a zinc coated metallic substrate prepared without using the zinc plating bath additive of the instant invention.

Example 3
The properties of the present zinc plating bath additives on the adhesion of the coating determined by the formation of blisters were demonstrated in aqueous alkaline plating baths for which an electrolyte composition as outlined in table 6 below was prepared.

Table 6: Electrolyte composition of the aqueous alkaline plating bath

<table>
<thead>
<tr>
<th>Ingredient</th>
<th>Amount based on bath</th>
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</thead>
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<tr>
<td>Zinc oxide</td>
<td>14.94 g/L</td>
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<td>Sodium hydroxide</td>
<td>130.0 g/L</td>
</tr>
<tr>
<td>Sodium carbonate</td>
<td>40.0 g/L</td>
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</tbody>
</table>

To the electrolyte composition of table 6 further additives as outlined in table 7 below were added.

Table 7: Further additives of the aqueous alkaline plating bath

<table>
<thead>
<tr>
<th>Further additive*</th>
<th>Amount† based on bath</th>
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</thead>
<tbody>
<tr>
<td>Polarization reagent</td>
<td>3.0 g/L</td>
</tr>
<tr>
<td>Basic brightener</td>
<td>1.1 g/L</td>
</tr>
<tr>
<td>High-gloss brightener</td>
<td>50.0 mg/L</td>
</tr>
</tbody>
</table>

* : the polarization reagent is a commercially available cationic reaction product of N,N'-bis[3-(dialkylamino)alkyl]ureas with I,ω-dihalogen alkane having an active content of ~ 62 wt.-%; the basic brightener is a commercially available copolymer of imidazole and epichlorohydrin having
an active content of ~ 45 wt.-% and the high-gloss brightener is a commercially available n-benzylnicotinate having an active content of ~ 48 wt.-%.

*: amount of ingredient is base on the amount of the active material.

5 To the aqueous alkaline plating bath obtained from the ingredients and the further additives described in tables 6 and 7, a zinc plating bath additive as outlined in table 8 below was added in an amount of 1.0 g/L bath, based on the active material. Examples marked with (+) serve for comparison.

10 Each bath was added to a parallel cell in which punched steel panels were plated at a current of 1 A/dm² for 50 min, 0.5 A/dm² for 75 min or 3 A/dm² for 25 min on both sides. A soluble zinc anode served as anode. The bath was operated at room temperature (about 20 °C ± 1 °C). The steel panels (steel number 1.0330 according to EN 10027-2) had the dimensions 70x100x0.3 mm. For each zinc plating bath additive three tests were carried out under the same conditions.

15 Before the steel panels were placed in the parallel cell, each steel panel was acid cleaned by using hydrochloric acid (15%), and rinsed with water. Then, each steel panel was subjected to an alkaline degreasing by using an aqueous degreasing solution as outlined in table 8. After the alkaline degreasing, each steel panel was rinsed with water, dried until moisture is no longer visible and weighed.

20 Table 8: Composition of the aqueous degreasing solution

<table>
<thead>
<tr>
<th>Ingredient</th>
<th>Amount</th>
</tr>
</thead>
<tbody>
<tr>
<td>NaOH (pA)</td>
<td>20 g/L</td>
</tr>
<tr>
<td>Na₂CO₃ (LPW quality)</td>
<td>22 g/L</td>
</tr>
<tr>
<td>Na₃PO₄ x 12 H₂O (pure)</td>
<td>16 g/L</td>
</tr>
<tr>
<td>Trilon® powder #¹</td>
<td>1 g/L</td>
</tr>
<tr>
<td>Lutensol® AP 10 #²</td>
<td>0.5 g/L</td>
</tr>
</tbody>
</table>

#¹ is the chelating agent tetrasodium salt of ethylenediaminetetraacetic acid and is commercially available from BASF, Germany.

#² is a non-ionic surfactant and is commercially available from BASF, Germany.

25 The aqueous degreasing solution was prepared by dissolving and mixing the single ingredients in distilled water such that a clear solution is obtained.

After the coating, the steel panels were rinsed with water, dried until moisture is no longer visible and weighed. Then, the steel panels were wrapped in a foil and stored 3 months at room temperature (about 20 °C ± 1 °C). Subsequently, the steel panel surfaces were evaluated with regard to the formation of pits and blisters. For this, a pressure-sensitive adhesive tape having a
width of at least 50 mm and a bonding strength of 6-10 N/25 mm width was attached on the surface of each coated steel panel. The adhesive tapes were evenly pressed on the steel panel surfaces by hand (the even adhesion can be controlled by the color of the steel panel surfaces through the tape) and then quickly removed from the surfaces. The tape removal was carried out by removing the tapes from the steel panel surfaces within 0.5-1 s in an angle of about 60°.

The removal of the tapes was carried out within 5 min after their application on the steel panel surfaces. The tests were carried out at a temperature of about 23 °C ± 2 °C and a humidity of about 50 % ± 5 %. The evaluation of the steel panel surfaces was carried under good illumination from all sides with the naked eye.

The adhesion of the coating determined by the formation of pits and blisters observed on the obtained zinc coated substrates are summarized in table 9 below.

Table 9: The zinc plating bath additive and the coating adhesion of the obtained zinc coated substrate

<table>
<thead>
<tr>
<th>Test</th>
<th>Zinc plating bath additive</th>
<th>Coating adhesion after 3 months</th>
</tr>
</thead>
<tbody>
<tr>
<td>1(+)</td>
<td>--</td>
<td>formation of pits</td>
</tr>
<tr>
<td>2</td>
<td>Butyl glucosid</td>
<td>no blisters, good adhesion</td>
</tr>
<tr>
<td>3</td>
<td>2-Ethylhexyl glucosid</td>
<td>no blisters, good adhesion</td>
</tr>
<tr>
<td>4</td>
<td>Isoamyl xyllosid</td>
<td>no blisters, good adhesion</td>
</tr>
<tr>
<td>5</td>
<td>n-Butyl-glucosid-xyllosid</td>
<td>no blisters, good adhesion</td>
</tr>
</tbody>
</table>

From table 9, it can be gathered that a zinc coated metallic substrate prepared by using the zinc plating bath additive of the instant invention shows improved behavior as regards the formation of pits and blisters compared to a zinc coated metallic substrate prepared without using the zinc plating bath additive of the instant invention. Thus, it can be concluded that a zinc coated metallic substrate prepared by using the zinc plating bath additive of the instant invention has improved coating adhesion compared to a zinc coated metallic substrate prepared without using the zinc plating bath additive of the instant invention.

Example 4

The properties of the present zinc plating bath additives on the gloss of a coated cast iron were determined in aqueous alkaline plating baths for which an electrolyte/additive composition as outlined in table 10 below was prepared.

Table 10: Electrolyte composition of the aqueous alkaline plating bath
<table>
<thead>
<tr>
<th>Ingredient</th>
<th>Amount based on bath</th>
</tr>
</thead>
<tbody>
<tr>
<td>Zinc oxide</td>
<td>9.34 g/L</td>
</tr>
<tr>
<td>Sodium hydroxide</td>
<td>97.0 g/L</td>
</tr>
<tr>
<td>Sodium carbonate</td>
<td>35.0 g/L</td>
</tr>
<tr>
<td>High-gloss brightener*¹</td>
<td>50.0 mg/L</td>
</tr>
<tr>
<td>Butyl glucosid</td>
<td>2.0 g/L</td>
</tr>
</tbody>
</table>

*¹: the high-gloss brightener is a commercially available n-benzylnicotinate having an active content of ~ 48 wt.-%.

The electrodeposition of the zinc coating on the cast iron was carried out in a hull cell in accordance with DIN 50 957. The bath was added to a 250 mL hull cell in which a cast iron panel was plated at 3 A for 60 min. The cast iron panels were obtained from a cast iron grade according to ASTM A536 and had the dimensions 48x102x4.5mm. Before the cast iron panel was placed in the hull cell, the panel was acid cleaned by using hydrochloric acid (15%), subjected to an electrolytic degreasing and rinsed with water. A stainless steel anode served as anode. The bath was operated at room temperature (about 20 °C ± 1 °C).

The gloss unit determined by using the gloss meter Micro-Tri-Gloss of BYK Gardner, Germany (serial number: 9 014 327) at a measuring angle of 60° and 85° for the cast iron substrate coated with a zinc plating bath additive in accordance with the present invention as well as for the reference sample, i.e. the cast iron substrate is coated in the absence of the zinc plating bath additive of the present application, are outlined in table 11 below. The set-up is carried out in accordance with the operating instruction manual of the gloss meter Micro-Tri-Gloss. The gloss unit values are the average of ten measurements. The standard deviation of the gloss unit is ± 2 GU (GU = gloss unit).

<table>
<thead>
<tr>
<th>Zinc plating bath additive</th>
<th>Measuring angle</th>
<th>Gloss Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>--</td>
<td>60°</td>
<td>0.4</td>
</tr>
<tr>
<td>--</td>
<td>85°</td>
<td>0.1</td>
</tr>
<tr>
<td>Butyl glucosid</td>
<td>60°</td>
<td>1.9</td>
</tr>
<tr>
<td>Butyl glucosid</td>
<td>85°</td>
<td>0.7</td>
</tr>
</tbody>
</table>

From table 11, it can be gathered that a zinc coated cast iron substrate prepared by using the zinc plating bath additive of the instant invention shows improved gloss compared to a zinc coated cast iron substrate prepared without using the zinc plating bath additive of the instant invention.
CLAIMS

1. Process for the electrolytic deposition of a zinc or zinc alloy coating on a metallic
substrate, the process comprises at least the steps of:
   a) providing an aqueous alkaline plating bath comprising
      i) a source of zinc ions,
      ii) a source of hydroxide ions, and
      iii) a zinc plating bath additive being at least one compound of the general formula
          \[
          \text{O} \quad \frac{(G^1)_x}{R \quad \backslash \quad H} \quad (I)
          \]
          wherein R is C_{4-8}-alkyl; G^1 is selected from monosaccharides with 4 to 6
          carbon atoms; x is in the range of from 1 to 4 and refers to average values, and
   b) placing a metallic substrate in the aqueous alkaline plating bath such that a zinc or
      zinc alloy coating is formed on the metallic substrate.

2. The process according to claim 1, wherein the source of zinc ions is zinc oxide and/or
   the zinc ions are present in the aqueous alkaline plating bath in an amount of from 2.0 to
   30.0 g/L bath.

3. The process according to claim 1 or 2, wherein the source of hydroxide ions is sodium
   hydroxide and/or the hydroxide ions are present in the aqueous alkaline plating bath in
   an amount of from 50.0 to 250.0 g/L bath.

4. The process according to any one of claims 1 to 3, wherein in the general formula (I) R is
   C_{4-8}-alkyl; G^1 is selected from monosaccharides with 5 or 6 carbon atoms; and x is in
   the range of from 1 to 2.

5. The process according to any one of claims 1 to 4, wherein in the general formula (I) R is
   C_4-alkyl; G^1 is glucose and/or xylose and/or arabinose and x is in the range of from 1 to
   1.8.

6. The process according to any one of claims 1 to 5, wherein the zinc plating bath additive
   is present in the aqueous alkaline plating bath in an amount of from 0.1 to 10.0 g/L bath.
7. The process according to any one of claims 1 to 6, wherein the aqueous alkaline plating bath has a pH of from 12.0 to 14.0.

8. The process according to any one of claims 1 to 7, wherein the aqueous alkaline plating bath further comprises at least one conventional additive selected from the group comprising brightener such as high-gloss brightener, basic brightener and mixtures thereof, water-soluble polymers, leveling agents, water softener, complexing agents, a source of cyanide ions and mixtures thereof.

9. The process according to any one of claims 1 to 8, wherein process step b) is carried out at a temperature of from 10 to 40 °C.

10. The process according to any one of claims 1 to 9, wherein process step b) is carried out at a current density of from 0.05 to 15.0 A/dm².

11. The process according to any one of claims 1 to 10, wherein the zinc or zinc alloy coating formed on the metallic substrate has a thickness of from 2.0 to 30.0 μm.

12. A zinc or zinc alloy coated metallic substrate having a gloss being defined by inequation

\[(GU_{\text{with}}) / (GU_{\text{without}}) \geq 1.05 \]  

(l)

wherein

\((GU_{\text{without}})\) is the gloss unit determined on a metallic substrate coated without using the at least one compound of the general formula (I) defined herein and as measured with a gloss meter at a measuring angle of 85°,

\((GU_{\text{with}})\) is the gloss unit determined on a metallic substrate coated by using the at least one compound of the general formula (I) defined herein and as measured with gloss meter at a measuring angle of 85°.

13. An aqueous alkaline plating bath for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate, wherein the bath comprises

a) a source of zinc ions as defined in any one of claims 1 or 2,

b) a source of hydroxide ions as defined in any one of claims 1 or 3, and

c) a zinc plating bath additive being at least one compound of the general formula (I),
wherein G is C₄₋C₆-alkyl; G₁ is selected from monosaccharides with 4 to 6 carbon atoms; x is in the range of from 1 to 4 and refers to average values.

14. Use of a zinc plating bath additive in a process for the electrolytic deposition of a zinc or zinc alloy coating on a metallic substrate, wherein the zinc plating bath additive is at least one compound of the general formula (I),

\[
\begin{array}{c}
\text{p} \\
\hline
\text{R} \\
\hline
\text{H}
\end{array}
\]

wherein R is C₄₋C₆-alkyl; G₁ is selected from monosaccharides with 4 to 6 carbon atoms; x is in the range of from 1 to 4 and refers to average values.

15. Use of a zinc plating bath additive for improving the optical and/or mechanical surface properties of a zinc or zinc alloy coating on a metallic substrate, wherein the zinc plating bath additive is at least one compound of the general formula (I),

\[
\begin{array}{c}
\text{p} \\
\hline
\text{R} \\
\hline
\text{H}
\end{array}
\]

wherein R is C₄₋C₆-alkyl; G₁ is selected from monosaccharides with 4 to 6 carbon atoms; x is in the range of from 1 to 4 and refers to average values.

16. Use of a zinc plating bath additive for improving the optical and/or mechanical surface properties of a zinc or zinc alloy coating on a cast iron substrate, wherein the zinc plating bath additive is at least one compound of the general formula (I),

\[
\begin{array}{c}
\text{p} \\
\hline
\text{R} \\
\hline
\text{H}
\end{array}
\]

wherein R is C₄₋C₆-alkyl; G₁ is selected from monosaccharides with 4 to 6 carbon atoms; x is in the range of from 1 to 4 and refers to average values.
INTERNATIONAL SEARCH REPORT

International application No
PCT/EP2015/065014

A. CLASSIFICATION OF SUBJECT MATTER
ADD.

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)
C25D C25C C25C

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)
EPO-Internal, WPI Data

C. DOCUMENTS CONSIDERED TO BE RELEVANT

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<td>CN 103 122 468 A (YANGZHOU SHUANGSHENG ZINC INDUSTRY CO LTD) 29 May 2013 (2013-05-29) abstract</td>
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Further documents are listed in the continuation of Box C.

See patent family annex.

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- "E" earlier application or patent but published on or after the international filing date
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Date of the actual completion of the international search: 31 August 2015

Date of mailing of the international search report: 09/09/2015

Name and mailing address of the ISA/
European Patent Office, P.B. 5818 Patentlaan 2
NL-2280 HV Rijswijk
Tel. (+31-70) 340-2040, Fax: (+31-70) 340-3016

Authorized officer: Tel ias, Gabri e l a

Form PCT/ISA/210 (second sheet) (April 2005)
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